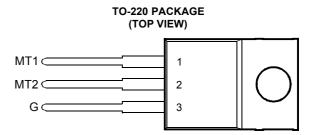
TIC236 SERIES SILICON TRIACS

DECEMBER 1971 - REVISED JUNE 2000

- High Current Triacs
- 12 A RMS
- Glass Passivated Wafer
- 400 V to 800 V Off-State Voltage
- Max I_{GT} of 50 mA (Quadrants 1 3)



Pin 2 is in electrical contact with the mounting base.

MDC2ACA

absolute maximum ratings over operating case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT		
	TIC236D		400		
Repetitive peak off-state voltage (see Note 1)	TIC236M	N	600	V	
	TIC236S	V _{DRM}	700	v	
	TIC236N		800		
Full-cycle RMS on-state current at (or below) 70°C case temperature (see Note 2)			12	А	
Peak on-state surge current full-sine-wave at (or below) 25°C case temperature (see Note 3)			100	А	
Peak gate current			±1	А	
Operating case temperature range			-40 to +110	°C	
Storage temperature range			-40 to +125	°C	
Lead temperature 1.6 mm from case for 10 seconds			230	°C	

NOTES: 1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal 1.

2. This value applies for 50-Hz full-sine-wave operation with resistive load. Above 70°C derate linearly to 110°C case temperature at the rate of 300 mA/°C.

3. This value applies for one 50-Hz full-sine-wave when the device is operating at (or below) the rated value of peak reverse voltage and on-state current. Surge may be repeated after the device has returned to original thermal equilibrium.

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	ТҮР	MAX	UNIT
I _{DRM}	Repetitive peak off-state current	V _D = Rated V _{DRM}	I _G = 0	T _C = 110°C			±2	mA
I _{GT}		V _{supply} = +12 V†	R _L = 10 Ω	t _{p(g)} > 20 μs		12	50	mA
	Gate trigger	V _{supply} = +12 V†	$R_L = 10 \ \Omega$	t _{p(g)} > 20 μs		-19	-50	
	current	V _{supply} = -12 V†	$R_L = 10 \ \Omega$	t _{p(g)} > 20 μs		-16	-50	
		V _{supply} = -12 V†	$R_L = 10 \ \Omega$	t _{p(g)} > 20 μs		34		
V _{GT}		V _{supply} = +12 V†	R _L = 10 Ω	t _{p(g)} > 20 μs		0.8	2	
	Gate trigger	$V_{supply} = +12 V^{+}$	$R_L = 10 \ \Omega$	t _{p(g)} > 20 μs		-0.8	-2	v
	voltage	V _{supply} = -12 V†	$R_L = 10 \ \Omega$	t _{p(g)} > 20 μs		-0.8	-2	
		V _{supply} = -12 V†	$R_L = 10 \ \Omega$	t _{p(g)} > 20 μs		0.9	2	
V _T	On-state voltage	$I_{TM} = \pm 17 \text{ A}$	l _G = 50 mA	(see Note 4)		±1.4	±2.1	V
I _H	Holding current	V _{supply} = +12 V†	l _G = 0	Init' I _{TM} = 100 mA		22	40	mA
	riolaing culterit	V _{supply} = -12 V†	$I_{G} = 0$	Init' I _{TM} = -100 mA		-12	-40	ШA

† All voltages are with respect to Main Terminal 1.

NOTE 4: This parameter must be measured using pulse techniques, $t_p = \le 1$ ms, duty cycle ≤ 2 %. Voltage-sensing contacts separate from the current carrying contacts are located within 3.2 mm from the device body.

PRODUCT INFORMATION

Information is current as of publication date. Products conform to specifications in accordance with the terms of Power Innovations standard warranty. Production processing does not necessarily include testing of all parameters.



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electrical characteristics at 25°C case temperature (unless otherwise noted) (continued)

PARAMETER		TEST CONDITIONS			MIN	ТҮР	MAX	UNIT
ΙL	Latching current	V _{supply} = +12 V† V _{supply} = -12 V†	(see Note 5)				80 -80	mA
dv/dt	Critical rate of rise of off-state voltage	V _D = Rated V _D	l _G = 0	T _C = 110°C		±400		V/µs
dv/dt _(c)	Critical rise of commutation voltage	V_D = Rated V_D di/dt = 0.5 I _{T(RMS)} /ms		$T_{C} = 80^{\circ}C$ $I_{T} = 1.4 I_{T(RMS)}$	±1.2	±9		V/µs
di/dt	Critical rate of rise of on -state current	V _D = Rated V _D di _G /dt = 50 mA/µs	I _{GT} = 50 mA	T _C = 110°C		±100		A/µs

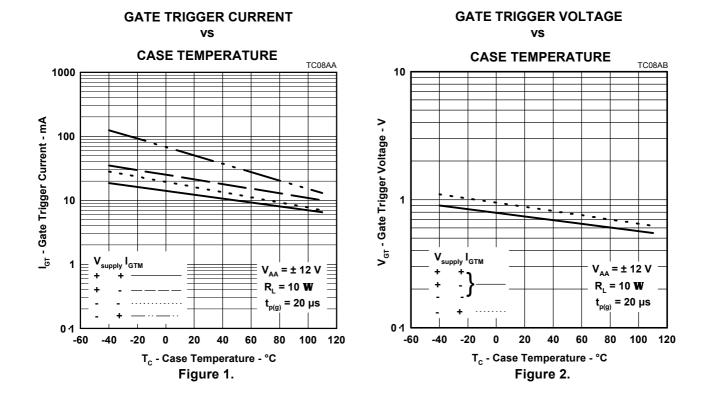
† All voltages are with respect to Main Terminal 1.

NOTE 5: The triacs are triggered by a 15-V (open-circuit amplitude) pulse supplied by a generator with the following characteristics: $R_G = 100 \Omega$, $t_{p(g)} = 20 \mu s$, $t_r = \le 15 ns$, f = 1 kHz.

thermal characteristics

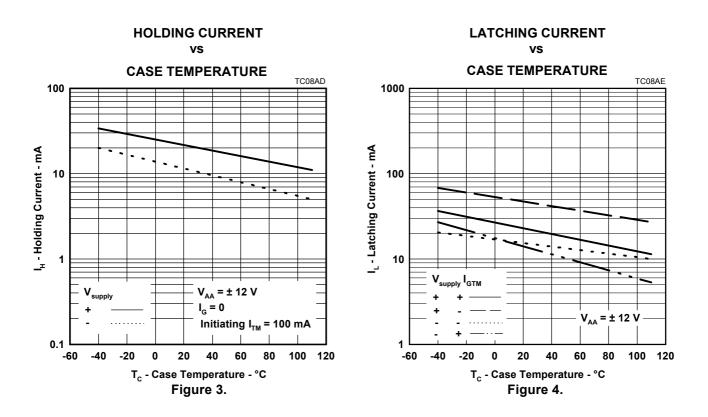
PARAMETER			ТҮР	MAX	UNIT
R _{θJ0}	Junction to case thermal resistance			2	°C/W
R _{θJ}	Junction to free air thermal resistance			62.5	°C/W

TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS

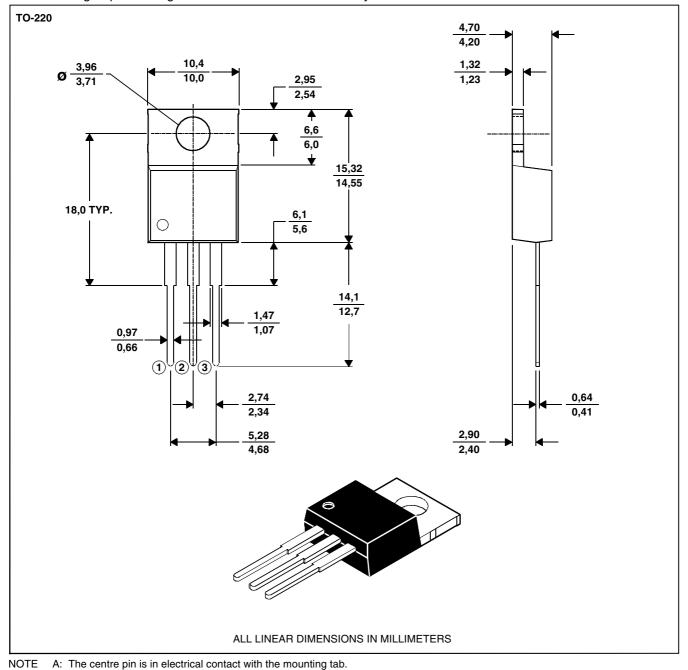


MECHANICAL DATA

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



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